## Overview





- 1. WLAN antennas (select models only)
- 2. Internal microphone
- 3. Webcam light
- 4. Webcam

- **Front View** 
  - 5. Touchpad with scroll zone
  - 6. TouchPad buttons
  - 7. Speaker
  - 8. Power button



# HP 245 G2 Notebook PC HP 255 G2 Notebook PC

## **Overview**



- 1. Duplicate power LED
- 2. Hard drive LED

**Right/Rear View** 

- 3. USB 2.0 ports (2)
- 4. Optical drive door



#### **Left View**

- 1. Security cable slot
- 2. Power connector
- 3. AC adaptor LED
- 4. VGA port

- 5. RJ-45 (Ethernet)
- 6. HDMI port
- 7. USB 3.0 port
- 8. Headphone / Microphone-in combo jack

# HP 255 G2 Notebook PC



## **Overview**



- 1. WLAN antennas (select models only)
- 2. Internal microphone
- 3. Webcam light
- 4. Webcam

- **Front View** 
  - 5. Touchpad with scroll zone
  - 6. TouchPad buttons
  - 7. Speaker
  - 8. Power button



## HP 245 G2 Notebook PC HP 255 G2 Notebook PC

## Overview



- Rigr
- Duplicate power LED
   Hard drive LED

- 3. USB 2.0 ports (2)
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- 1. Security cable slot
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- 3. AC adaptor LED
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### Left View

- 5. RJ-45 (Ethernet)
- 6. HDMI port
- 7. USB 3.0 port
- 8. Headphone / Microphone-in combo jack



## **Overview**

## **At A Glance**

- Windows 8.1 versions, Windows 7 versions, Ubuntu Linux, FreeDOS 2.0
- VISION Technology with AMD Mobility Radeon™ HD
- Durable, sophisticated design with textured-surfaced black licorice color.
- Full-sized keyboard with numeric keypad (HP 255 G2 only)
- VGA port and HDMI port (for connecting to high-resolution displays)
- Integrated HD webcam, integrated microphone
- Integrated 802.11 b/g/n wireless LAN module
- Optional Bluetooth<sup>™</sup> 2.1 or Bluetooth<sup>™</sup> 4.0
- 14.0" (HP 245 G2 Notebook PC) or 15.6" (HP 255 G2 Notebook PC) diagonal LED-backlit HD anti-glare display

NOTE: See important legal disclosures for all listed specs in their respective features sections.



## Features

# **PRODUCT NAMES**

HP 245 G2 Notebook PC HP 255 G2 Notebook PC

# **OPERATING SYSTEM**

Preinstalled

Windows 8.1 64\* Windows 8.1 Pro 64\* Windows 7 Professional 64 (available through downgrade rights from Windows 8.1 Pro 64)\*\* Windows 7 Home Basic 64\*\*\* Windows 7 Professional 64\*\*\* Ubuntu Linux FreeDOS 2.0

\* Not all features are available in all editions of Windows 8.1. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8.1 functionality. See <a href="http://www.microsoft.com">http://www.microsoft.com</a> for details. \*\* This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

\*\*\* Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

# **ACCELERATED PROCESSING UNIT**

### AMD

AMD Quad Core A6-5200 APU with Radeon<sup>™</sup> HD 8400 Graphics (2.0 GHz, 4 MB L2 cache, 4 cores)\* AMD Quad Core A4-5050 APU with Radeon<sup>™</sup> HD 8330 Graphics (1.5 GHz, 2 MB L2 cache, 4 cores)\* AMD Quad Core A4-5000 APU with Radeon<sup>™</sup> HD 8330 Graphics (1.5 GHz, 2 MB L2 cache, 4 cores)\* AMD Quad Core E2-3800 APU with Radeon<sup>™</sup> HD 8280 Graphics (1.3 GHz, 2 MB L2 cache, 4 cores)\* AMD Dual Core E1-2150 APU with Radeon<sup>™</sup> HD 8210 Graphics (1.05 GHz, 1 MB L2 cache, 2 cores)\* AMD Dual Core E1-2100 APU with Radeon<sup>™</sup> HD 8210 Graphics (1.0 GHz, 1 MB L2 cache, 2 cores)\*

\* This system requires a separately purchased 64-bit operating system and 64-bit software products to take advantage of the 64bit processing capabilities of AMD technology. Multi-core processing with AMD technology is designed to improve performance of this system. Given the wide range of SW applications available, performance will vary. AMD's numbering is not a measurement of clock speed.

# CHIPSET

AMD Kerala (Kabini SoC APU, BGA)



## Features

## GRAPHICS

### Integrated:

AMD Radeon<sup>™</sup> HD 8400 (AMD Quad Core A6-5200 APU) AMD Radeon<sup>™</sup> HD 8330 (AMD Quad Core A4-5000 APU and AMD Quad Core A4-5050 APU) AMD Radeon<sup>™</sup> HD 8280 (AMD Quad Core E2-3800 APU) AMD Radeon<sup>™</sup> HD 8210 (AMD Dual Core E1-2100 APU AMD Dual Core E1-2150 APU)

Discrete: AMD Radeon™ HD 8570M Graphics with up to 1024MB of dedicated video memory (Switchable Graphics)

## DISPLAY

#### HP 245 G2 Notebook PC

#### Internal

14.0"diagonal LED-backlit HD\* 16:9 widescreen BrightView (1366 x 768) 14.0"diagonal LED-backlit HD\* 16:9 widescreen BrightView (1366 x 768) (touch-enabled) **External** Up to 32-bit per pixel color depth **VGA** Port supports resolutions up to 2048 x 1536 external resolution @75 Hz **HDMI** 

1.4 port supports up to 1080p, 1920 x 1080 at 60Hz

### HP 255 G2 Notebook PC

#### Internal

15.6"diagonal LED-backlit HD anti-glare (1366 x 768) 15.6"diagonal LED-backlit HD anti-glare (1366 x 768) (touch-enabled) **External** Up to 32-bit per pixel color depth **VGA** Port supports resolutions up to 2048 x 1536 external resolution @ 75Hz **HDMI**\* 1.3 port supports up to 1080p, 1920 x1080 at 60Hz and 1920 x1200 @ 60Hz DVI Mode

\*HDMI cable sold separately.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.



## Features

## **STORAGE AND DRIVES**

#### Primary Storage Bay Hard Drives 320/500/750 GB/1 TB 5400 rpm SMART SATA II

**NOTE:** For hard drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software.

## **OPTICAL DRIVES**

### **Fixed Optical Drive**

DVD+/-RW SuperMulti DL Drive\*

\* Double-layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Note that DVD-RAM cannot read or write to 2.6 GB single-sided/5.2 GB double-sided - version 1.0 media. Don't copy copy-right protected materials.

## MEMORY

Standard DDR3L SDRAM (1600 MHz)\* One SODIMM slot supporting single channel\* SODIMMs Standard memory up to 8192MB

Maximum Upgradeable to 8192 MB with optional 8192 MB\* SODIMM in slot 1

\* Maximum memory speed supported by the system may be 1333 MHz or 1066 MHz.

**NOTE:** Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

\*Maximum memory capacities assume Windows 64-bit operating systems or Linux. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.



### Features

# **NETWORKING/COMMUNICATIONS**

### Wireless

802.11b/g/n (1x1) wireless LAN module<sup>1,2</sup> Qualcomm 802.11 b/g/n (1x1) wireless LAN module<sup>1,2</sup> Optional Ralink 802.11 b/g/n (1x1) + Bluetooth® 4.0 Combo<sup>1,2</sup> Optional Bluetooth® 2.11,2 or Bluetooth® 4.0 <sup>1,2</sup>

### Communications

Realtek Ethernet (10/100 NIC)

1. Sold separately or as an optional feature.

2. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

## AUDIO/MULTIMEDIA

#### Audio

High Definition Audio support Integrated Stereo Speakers Integrated microphone

#### Webcam

Integrated HD\* Webcam\*\*

- Supports videoconferencing and still image capture
- Improved quality for video streaming and still image capture (1280x720 resolution)
- Up to 30 frames/sec
- Fixed focus lens

### \* HD content required to view HD images.

\*\* Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

## **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

The 101/102-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, and function keys. US and International key layouts are available. Includes a separate numeric keypad (HP 255 G2 only).

### **Pointing Devices**

Touchpad with 2-piece pick button with left and right click functions

#### **Buttons and Function Keys**

Multi-touch gestures supported



### Features

## SOFTWARE AND SECURITY

### Preinstalled Software with Windows Operating System

Buy Office Recovery Manager Installer Cyberlink Youcam DE Cyberlink Power DVD (available on select models) McAfee™ Internet Security\* Getting Started with Windows 8.1

### Security

Security Lock slot (lock must be purchased separately)

\* Internet access required. First 60 days included. Subscription required for live updates afterwards.

## POWER

### **Power Supply**

External 45W AC adapter (UMA only) External 65W AC adapter (available for UMA and discrete)

#### **Primary Battery**

HP 3-cell (31 WHr) polymer battery (Available December 2013) HP 4-cell (41 WHr) polymer battery

#### **Battery Life**

HP 25

#### HP 245 G2 Notebook PC

Up to TBD hours
Up to TBD hours
Up to TBD hours Up to TBD hours

#### **System Standby Time**

Up to 1 week\*

\*Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

#### **Power Conservation**

Hibernation\* Standby\* ACPI compliance\*

\* Only Linux will feature power conservation.



Features

## **WEIGHTS & DIMENSIONS**

### HP 245 G2 Notebook PC

### Weight

Starting at < 4.85 lb (2200 g) (Non-Touch) (Weight will vary by configuration) Starting at < 5.29 lb (2400 g) (Touch) (Weight will vary by configuration)

**Dimensions** (w x d x h) Non-Touch

13.62 x 9.45 x 1.11 in 346 x 240 x 28.1 mm

### Touch

13.62 x 9.45 x 1.16 in 346 x 240 x 29.5 mm

### HP 255 G2 Notebook PC

#### Weight

Starting at < 5.51 lb (2500 g) (Non-Touch) (Weight will vary by configuration) Starting at < 6.17 lb (2800 g) (Touch) (Weight will vary by configuration)

#### Dimensions (w x d x h)

Non-Touch 14.90 x 10.2 x 1.11 in 378.4 x 259.2 x 28.1 mm

#### Touch

14.90 x 10.2 x 1.17 in 378.4 x 259.2 x 29.8 mm

**NOTE:** Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components.



## Features

# **PORTS/SLOTS**

### Ports

VGA - One HDMI\* - One Headphone / Microphone-in combo jack - One Power Connector - One RJ-45 (Ethernet) - One USB 3.0 - One USB 2.0 - Two

### **Digital Media Slots**

Supports SD (Secure Digital) Supports mini versions with adapter

\* HDMI cable sold separately.

## **SERVICE AND SUPPORT**

HP Services offers limited 1-year warranty options depending on country;

1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. Optional\* HP Care Pack Services\*\* are extended service contracts which go beyond your standard warranties. For more details visit: http://www.hp.com/go/lookuptool.

\*Sold separately or as an optional feature.

\*\* Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp

**NOTE:** Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc

# **Technical Specifications**

## SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	18.5/19.5V
	Average Operating Power	Integrated graphics: 12.55 W**AMD E-series platform
	Max Operating Power	< 65 W
Temperature	Operating	32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)
	Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	Operating	10% to 90%, non-condensing
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	Operating	40 G, 2 ms, half-sine
	Non-operating	200 G, 2 ms, half-sine
Random Vibration	Operating	0.75 grms
	Non-operating	1.50 grms
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry	UL	Yes
Standard	CSA	Yes
Certifications	FCC Compliance	Yes
	ENERGY STAR®	Select models*
	EPEAT	Registered Silver in United States**
	ICES	Yes
	Australia /	Yes
	NZ A-Tick Compliance	
	כככ	Yes
	Japan VCCI Compliance	Yes
	KC	Yes
	BSMI	Yes
	CE Marking Compliance	Yes
	BNCI or BELUS	Yes
	CIT	Yes
	GOST	Yes
	Saudi Arabian Compliance (ICCP)	Yes
	SABS	Yes
	UKRSERTCOMPUTER	Yes



## **Technical Specifications**

\* Configurations of the HP 245 G2 and HP 255 G2 Notebook PCs that are ENERGY STAR qualified are identified as HP 245 G2 ENERGY STAR and HP 255 G2 ENERGY STAR on HP websites and on www.energystar.gov.

\*\* EPEAT registration varies by country. See <a href="https://www.epeat.net">www.epeat.net</a> for registration status by country. EPEAT status listed above applies to U.S.

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

## DISPLAYS

14.0-inch LED HD	Active Area (w x h)	12.16 x 6.85 in (30.9 x17.4	cm)
(1366 x 768) BrightView	Diagonal Size	14.0 in (35.6cm)	
	Surface Treatment	BrightView	
	Contrast Ratio	300:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	Pixel Resolution	Pitch	0.252 mm
		Format	1366 x 768
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	101 ppi	
	Viewing Angle	±40° Horizontal, ±10°/-30 40/40/30/10 (Left/Right/E	
15.6" LED HD anti-glare	Active Area (w x h)	13.54 x 7.59 in (34.4 x 19.4	1 cm)
(1366 x 768)	Diagonal Size	15.6 in (39.6cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	<b>Pixel Resolution</b>	Pitch	0.252 mm
		Format	1366 x 768
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	101 ppi	
	Viewing Angle	±40° Horizontal, +10°/-30° 40/40/30/10 (Left/Right/D	

## **STORAGE AND DRIVES**

#### **Internal Storage**



# **Technical Specifications**

1 TB* 5400 rpm	Di	rive Weight	0.254 lb (115 g)	
SATA Hard Drive		apacity	1 TB	
		eight	0.37 in (9.5 mm)	
		idth	2.75 in (70 mm)	
	In	terface	ATA-8, SATA 2.6, 3.0 Gb/s, I	NCQ
	Tr	ransfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Se	eek Time	Single Track	3 ms
	(ty	ypical reads, including	Average	13 ms
	se	ettling)	Maximum	24 ms
	Ro	otational Speed	5400 rpm	
	La	ogical Blocks	1,953,525,168	
	01	perating Temperature	32° to 140° F (0° to 60° C) [o	case temp]
	Fe	eatures	ATA Security	
750 GB* 5400 rp	m Dı	rive Weight	0.22 lb (101 g)	
SATA Hard Drive	e Ca	apacity	750 GB	
	He	eight	0.37 in (9.5 mm)	
	W	idth	2.75 in (70 mm)	
	In	terface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ
	Tr	ransfer Rate	Synchronous (maximum)	300 MB/s (Drive Capability)
	Se	eek Time	Single Track	3 ms
	-	ypical reads, including	Average	13 ms
	se	ettling)	Maximum	24 ms
	Ro	otational Speed	5400 rpm	
	La	ogical Blocks	1,465,149,168	
	0	perating Temperature	32° to 140° F (0° to 60° C) [	case temp]
	Fe	eatures	ATA Security	



## **Technical Specifications**

500 GB* 5400 rpm	Drive Weight	0.22 lb (101 g)		
SATA Hard Drive	Capacity	500 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ		
	Transfer Rate	Synchronous (maximum)	150 MB/s (Drive Capability)	
	Seek Time	Single Track	3 ms	
	(typical reads, including	Average	13 ms	
	settling)	Maximum	24 ms	
	<b>Rotational Speed</b>	5400 rpm		
	Logical Blocks	976,773,168		
	<b>Operating Temperature</b>	32° to 140° F (0° to 60° C)	[case temp]	
	Features	ATA Security		
320 GB* 5400 rpm	Drive Weight	0.22 lb (101 g)		
SATA Hard Drive	Capacity	320 GB		
	Height	0.37 in (9.5 mm)		
	Width	2.75 in (70 mm)		
	Interface	ATA-8, SATA 2.6, 3.0 Gb/s,	NCQ	
	Transfer Rate	Synchronous (maximum)	150 MB/s (Drive Capability)	
	Seek Time	Single Track	3 ms	
	(typical reads, including	Average	13 ms	
	settling)	Maximum	24 ms	
	<b>Rotational Speed</b>	5400 rpm		
	Logical Blocks	625,142,448		
	<b>Operating Temperature</b>	32° to 140° F (0° to 60° C)	[case temp]	
	Features	ATA Security		
	* For hard drives and solid	state drives, GB = 1 billion by	ytes. TB = 1 trillion bytes. Actual format	

\* For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 8.1) of system disk is reserved for the system recovery software.

### **Optical Drives**

# **Technical Specifications**

DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM	
		8X DVD	
		24X CD-R	
		24X CD-RW	
		8X DVD+R	
		8X DVD+RW	
		8X DVD-R	
		6X DVD-RW	
		5X DVD-RAM	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	(Photo-CD, Video CD), Mult	CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge cisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, D-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, V, DVD-RAM
	Supported Media (write)	CD-R, CD-RW, DVD+R, DVD DL	+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R
	Max Media Capacity (read)	8.5 GB	
	<b>Max Media Capacity</b> (write)	8.5 GB	
	Transport	Tray Loading	

# **NETWORKING/COMMUNICATIONS**

Networking		
Integrated Realtek 10/100 NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable
	Power Management	ACPI compliant - multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Large send offload and Giant send offload Receiving Side Scaling
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot



Technical Specificat	tions	
		Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface	PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ
	NIC Device Driver Name	Realtek PCIe FE Ethernet Family Controller
Communications		
Atheros 802.11b/g/n WiFi Adapter*, **	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Win7, (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.402 - 2.482 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n150Mbps for MCS7
	Frequency Support	20 MHz: 2.4 GHz bands
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security <sup>1</sup>	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST. Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 5) with Microsoft Windows 7only.
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power <sup>2</sup>	13.5 dBm, minimum
	Power Consumption	Idle associated: 250 mW avg (CLKREQ enabled) Idle unassociated: 100 mW avg Transmit/Receive channel: 2.0 /1.6 W
	Power Management	ACPI compliant power management 802.11 compliant power saving mode
	Receiver Sensitivity <sup>3</sup>	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.
	Antenna type	High efficiency dual antenna with spatial diversity, usually mounted in the display enclosure
	Form Factor	PCI-Express Half-MiniCard

# **Technical Specifications**

	Weight	4 g	
	Dimensions	3.3 x 26.65 x 29.85 mm	
	Operating Voltage	3.3v +/- 9%	
	Temperature	Operating Non-operating	-10° to 70° C -40° to 80° C
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	Amber LED on-Radio OFF;	White LED on-Radio ON
	<ol> <li>Maximum output po</li> <li>Receiver sensitivity</li> </ol>	wer may vary by country ac	s on supported security features. cording to local regulations. or rate of 8% for 802.11b (CCK modulation) and a nodulation).
	Windows XP. WLAN may al IHV extensions required fo	so be compatible with certai r Cisco Compatible Extension I internet service required. A	o Compatible Extensions support with Microsoft in third-party software supplicants. WLAN supplier ns support for Microsoft Windows Vista and Win7. wailability of public wireless access points limited.
Qualcomm 802.11b/g/n WiFi Adapter*, **	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n	
	Interoperability	Wi-Fi certified Cisco Compatible Extensio at: http://www.hp.com/go	ns Program compliant with Microsoft Win7, (details o/notebooks/WLAN)
	Frequency Band	2.402 - 2.482 GHz	
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 3 802.11n150Mbps for MCS	36, 48, 54 Mbps
	Frequency Support	20 MHz: 2.4 GHz bands	
	Modulation	Direct Sequence Spread Sp DBPSK, DQPSK, CCK, OFDM	oectrum 1, BPSK, QPSK, 16-QAM, 64-QAM
	Security <sup>1</sup>		WEP, WPA, WPA2, hardware-accelerated AES, es EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2,
		•••	Features (proven compatibility with Cisco Aironet rough the Cisco Compatible Extensions Program Nindows7only.
	Sub-channels	Multinational support with regulations.	rfrequency bands and channels compliant to local
	Media Access Protocol	CSMA/CA (Collision Avoida	nce) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Poir	nt Required)



## **Technical Specifications**

Roaming	IEEE 802.11 compliant roaming between access points		
Output Power <sup>2</sup>	13.5 dBm, minimum		
Power Consumption	Idle associated: 250 mW av Idle unassociated: 100 mW Transmit/Receive channel:	avg	
Power Management	ACPI compliant power man 802.11 compliant power sa	-	
Receiver Sensitivity <sup>3</sup>	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.		
Antenna type	High efficiency dual antenna with spatial diversity, usually mounted in the display enclosure		
Form Factor	PCI-Express Half-MiniCard v1.2		
Weight	4 g		
Dimensions	3.3 x 26.65 x 29.85 mm		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	-10° to 70° C -40° to 80° C	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	Amber LED on-Radio OFF; White LED on-Radio ON		
1 Charly latest software /driver release for undates on supported security features			

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

**NOTE:** WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7. \* Wireless access point and internet service required. Availability of public wireless access points limited. \*\* Sold separately or as an optional add-on feature.

Ralink 802.11b/g/n Bluetooth 4.0 Combo Card*	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows7 (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.402 - 2.482 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 150Mbps for MCS7



Technical Specificati	ons		
	Modulation	Direct Sequence Spread S DBPSK, DQPSK, CCK, OFDN	pectrum 4, BPSK, QPSK, 16-QAM, 64-QAM
	Security <sup>1</sup>		WEP, WPA, WPA2, hardware-accelerated AES, les EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2,
		infrastructure products th	Features (proven compatibility with Cisco Aironet rough the Cisco Compatible Extensions Program Windows Vista and XP only.
	Sub-channels	Multinational support with regulations.	h frequency bands and channels compliant to local
	Media Access Protocol	CSMA/CA (Collision Avoida	ince) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Poi	nt Required)
	Roaming	IEEE 802.11 compliant roa	aming between access points
	Output Power (for CCK) <sup>2</sup>	13.5dBm , minimum	
	Power Consumption	Idle associated: 250 mW Idle unassociated: 150 mV Transmit: 2.0 W (max) Receive: 2.0 W (max)	V
	Power Management	ACPI compliant power mai 802.11 compliant power s	-
	Receiver Sensitivity <sup>3</sup>	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.	
	Antenna type	High efficiency dual anten enclosure	na with spatial diversity, mounted in the display
	Form Factor	PCI-Express Half-MiniCarc	1 v1.2
	Weight	6 g	
	Dimensions	3.3 x 26.65 x 29.85 mm	
	Operating Voltage	3.3v +/- 10%	
	Temperature	Operating Non-operating	14° to 149° F (-10° to 65° C) -40° to 176° F (-40° to 80° C)
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	LED Off - Radio OFF; Solid	LED On - RadioON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

**NOTE:** WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7.



# **Technical Specifications**

### **Bluetooth Specification**

Bluetooth Specification	
V4.0 High Speed, V2.1+E	DR, backwards compatible with V1.1, 1.2 and 2.0
Number of Available Channels	79 (1 MHz) available channels
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	-6 dBm to 4 dBm (Bluetooth Class II)
Receiver Sensitivity	Better than -80 dBM at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Sleep <17 mW
Antenna	Internally integrated within module
Range	Up to 33 ft (10 m)
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug and Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	Generic Access Profile (GAP) Service Discovery Application Profile (SDAP) Serial Port Profile (SPP) Dial_Up Networking Profile (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP)



# **Technical Specifications**

Basic Printing Profile (BPP) VDP (Video Distribution Profile) AVRCP (Audio Video Remote Control Profile)

\* Wireless access point and internet service required. Availability of public wireless access points limited.

\*\* Sold separately or as an optional add-on feature.

## AUDIO/MULTIMEDIA

Audio

Hardware	Implementation	Realtek ALC3201-GR High Definition audio
	Volume Controls	Up, down, and mute function keys
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes
Audio Output Quality	Frequency Response	10 Hz ~ 22 KHz
	Signal to Noise Ratio	Typical 95 dB FSA (DAC)
	Total Harmonic Distortion	1 Typical -88 dB FS (DAC)
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	Up to 192 KHz
	DAC	24 bits
	ADC	24 bits
Integrated Stereo	Power Rating	1.5 W
Speakers	Impedance	4 ohms
Multimedia		
Integrated HD Webcam	Supports videoconferencing and still image capture Improved quality for video streaming and still image capture (1280x720 resolution) Up to 30 frames/sec Fixed focus lens	
POWER		



Technical Specification	ons		
HP 45W Smart AC Adapter	Dimensions	3.78 x 1.95 x 0.88 in (9.6 x 4.95 x 2.24 cm)	
	Input	90 to 265 VAC	
		Input Efficiency	87% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	1.4 A at 90 VAC and maximum load
	Output	Output power	45W
		DC output	19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<8A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords	
	Environmental Design	Operating temperature	32° to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° to 121° F (-20° to 85° C)
		Altitude	0 to 16,405 ft (0 to 5,000 m)
		Humidity	0% to 95%
		Storage Humidity	0% to 95%
	Certificationsstandards - IEC60950, EN60950, UL60C-UL-US, NORDICS, DENAN, EN55022 C		vith LVD and EMC directives; Worldwide safety 0950, UL60950, Class1, SELV; Agency approvals - , EN55022 Class B, FCC Class B, CISPR22 Class B, ty - failure rate of less than 0.1% annually within ration.
HP 65W AC Adapter	Dimensions	4.21 x 1.85 x 1.18 in (10.7 ;	x 4.7 x 3.0 cm)
	Weight	0.62 lb (280 g)	
	Input	100 to 240 VAC	
	•	Input Efficiency	87% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	1.7 A at 90 VAC
	Output	Output power	65W
		DC output	18.5/19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords	
	Environmental Design	Operating temperature	41° to 95° F (5° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 5,000 ft (0 to 1,524 m)



# **Technical Specifications**

		Humidity	20% to 95%	
		Storage Humidity	10% to 95%	
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approval C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class E CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.		
4-Cell (41 WHr)	Cells/Type	4-cell Lithium-Ion		
Lithium-Ion battery	Energy Temperature	Watt-hour capacity	41 WHr	
		Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (-10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
HP 3-cell (31 WHr) Lithium-Ion Primary	<b>Dimensions</b> (h x w x l)	0.8 x 1.2 x 8.1 in (2 x 3 x 20.5cm)		
battery	Weight	0.37lb, (0.166kg)		
	Cells/Type	Lithium-Ion		
	Energy	Voltage	11.1V	
		Amp-hour capacity	2.8Ah	
		Watt-hour capacity	31Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 122° F(-10° to 50° C)	
		Non-operating	-4° to 122° F (-20° to 50° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours	
		System ON	3 to 5 hours	
	Fuel Gauge LED	No		
	Warranty	1 year		



## **Technical Specifications**

# **Environmental Data**

## HP 240 G2 Notebook PC

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Silver registered in the United States. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status in your country.

System Configuration

Eco-Label

Sleep Off

Certifications & Declarations

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

### Energy Consumption (in accordance with US ENERGY STAR® test method) Normal Operation

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
6.17 W	6.27 W	6.37 W
0.58 W	0.61 W	0.58 W
0.52 W	0.57 W	0.52 W

### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	21 BTU/hr	21 BTU/hr	22 BTU/hr
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr

\* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



# HP 245 G2 Notebook PC HP 255 G2 Notebook PC

# **Technical Specifications**

<b>Declared Noise Emissions</b>				
(in accordance with	Sound Power	Sound Pressure		
ISO 7779 and ISO 9296)	(LWAd, bels)	(LpAm, decibels)		
Typically Configured – Idle	1.8	21		
Fixed Disk - Random writes	4.1	36		
Batteries	This battery(s) in this product comply with EU Direc	ctive 2006/66/EC		
	Batteries used in the product do not contain:			
	<ul> <li>Mercury greater the1ppm by weight</li> <li>Cadmium greater than 20ppm by weight</li> </ul>			
	Battery size: CR2032 (coin cell) Battery type: Lithium			
Additional Information	<ul> <li>2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drin Water and Toxic Enforcement Act of 1986).</li> </ul>			
	<ul> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the <silver> level, see     www.epeat.net</silver></li> </ul>			
	<ul> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> </ul>			
	<ul> <li>This product contains 0% post-consumer recycled plastic (by wt.)</li> <li>This product is 96.3% recycle-able when properly disposed of at end of life.</li> </ul>			
	Packaging Materials			
	<ul> <li>External:</li> <li>PAPER/Corrugated 374 g</li> </ul>			
	<ul> <li>Internal:         <ul> <li>PLASTIC/EPE (Expanded Polyethylene</li> <li>PLASTIC/Polyethylene low density 31</li> <li>PLASTIC/Polypropylene 24</li> </ul> </li> </ul>	.7 g		
	<ul> <li>The PAPER/Corrugated packaging material i</li> <li>The PLASTIC/EPE (Expanded Polyethylene) p content.</li> </ul>	s made from 74 % recycled content. Dackaging materials contains at least 0% recycled		
		aging materials contains at least 0% recycled		

content.
The PLASTIC/Polypropylene packaging materials contains at least 0% recycled content.



# **Technical Specifications**

# HP 255 G2 Notebook PC

	-		
Eco-Label	This product has received or is in the process of being certified to the following approvals and may		
Certifications	be labeled with one or more of these marks:		
& Declarations	<ul> <li>IT ECO declaration</li> <li>US ENERGY STAR<sup>®</sup></li> <li>EPEAT Silver registered in the in your country.</li> </ul>	e United States. See http://w	ww.epeat.net for registration status
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".		
Energy Consumption			
(in accordance with US ENERGY			
STAR <sup>®</sup> test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	5.34 W	5.47 W	5.48 W
Sleep	0.94 W	1.01 W	0.94 W
Off	0.38 W	0.45 W	0.38 W
	NOTE:		
	Energy efficiency data listed is for a family. HP computers marked with Environmental Protection Agency (E family does not offer ENERGY STAR for a typically configured PC featuri Microsoft Windows® operating syst	the ENERGY STAR <sup>®</sup> Logo are EPA) ENERGY STAR <sup>®</sup> specifica <sup>®</sup> compliant configurations, f ng a hard disk drive, a high e	compliant with the applicable U.S. ations for computers. If a model then energy efficiency data listed is
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	18 BTU/hr	19 BTU/hr	19 BTU/hr
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr
Off	1 BTU/hr	2 BTU/hr	1 BTU/hr
	* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
Declared Noise Emissions			
(in accordance with ISO 7779 and ISO 9296)	Sound Power (LWAd, bels)		Sound Pressure (LpAm, decibels)
Typically Configured - Idle	3.2 28		28
Fixed Disk - Random writes	4.1 36		36
Batteries	This battery(s) in this product comp	ly with EU Directive 2006/66	/EC
	Batteries used in the product do not contain:		
	<ul> <li>Mercury greater the1ppm by</li> <li>Cadmium greater than 20ppr</li> </ul>	-	
	Battery size: CR2032 (coin cell) Battery type: Lithium		
Additional Information	2011/65/EC.		ardous Substances (RoHS) directive - ctrical and Electronic Equipment



## **Technical Specifications**

HP 245 G2 Notebook PC HP 255 G2 Notebook PC

(WEEE) Directive - 2002/96/EC.

- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the <Silver> level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0% post-consumer recycled plastic (by wt.)
- This product is 96.3% recycle-able when properly disposed of at end of life.

### Packaging Materials

• External:

• PAPER/Corrugated 433 g

- Internal:
  - O PLASTIC/EPE (Expanded Polyethylene) 33 g
  - O PLASTIC/Polyethylene low density 33.4 g
  - PLASTIC/Polypropylene 24.5 g
- The PAPER/Corrugated packaging material is made from 74 % recycled content.
- The PLASTIC/EPE (Expanded Polyethylene) packaging materials contains at least 0% recycled content.
- The PLASTIC/Polyethylene low density packaging materials contains at least 0% recycled content.
- The PLASTIC/Polypropylene packaging materials contains at least 0% recycled content.

## ALL MODELS

### **MATERIAL USAGE**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances



## **Technical Specifications**

• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

### **PACKAGING USAGE**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

### END-OF-LIFE MANAGEMENT AND RECYCLING

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

## HEWLETT-PACKARD CORPORATE ENVIRONMENTAL INFORMATION

For more information about HP's commitment to the environment:

Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC\_GBU\_Product\_Design\_ISO\_14K\_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

## **COUNTRY OF ORIGIN**

China



# Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Docking	HP USB 3.0 Port Replicator	H1L08AA#xxx
	HP Dual Hinge Notebook Stand	AW661AA#xxx
Carrying Cases	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
	HP Professional Series Carrying Case (up to 15.6")	H4J90AA
	HP Business Backpack (up to 17.3")	H5M90AA
	HP Business 4 Wheel Roller Case	Н5М9ЗАА
Input/Output	HP USB Essential Keyboard/Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Stylish USB Keyboard/Mouse	H4B80AA
Adapters	HP 65W Slim Adapter	AX727AA#XXX
	65W Smart AC Adapter	ED494AA#xxx
	90W Smart AC Adapter	ED495AA#xxx
	90W Slim Adapter	BT796AA#xxx
	HP 65W Smart AC Adapter	Нбү89АА
	HP 90W Smart AC Adapter	H6Y90AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 90W Slim AC Adapter	Нбүвзаа
Health and Education	20 Notebook Managed Charging Cart	QL489AA#xxx
	30 Notebook Managed Charging Cart	QL490AA
Security	HP UltraSlim Keyed Cable Lock	H4D73AA
Storage	HP Mobile USB DVDRW Non-LS	A2U57AA
Monitors	HP EliteDisplay E271i 27-inch IPS LED Monitor	D7Z72AA/A8/AS/AT
	HP EliteDisplay E231 23-inch LED Monitor	C9V75AA/A8/AS/AT
	HP EliteDisplay E201 20-inch LED Monitor	C9V73AA/A8/AS/AT
	HP ProDisplay P221 21.5" LED Monitor	C9E49AA/A8/AS/AT
	HP ProDisplay P201 20" LED Monitor	C9F26AA/A8/AS/AT



## Options and Accessories (sold separately and availability may vary by country)

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